





Click here for the 3D model.

Dimensions	
Case Code	4B
L	4.1mm +/-0.38mm
W	6.1mm +/-0.2mm
Н	4.3mm +/-0.38mm
S	0.76mm +/-0.38mm
F	5.3mm +/-0.2mm
К	3.1mm +/-0.38mm

Packaging Specifications	
Packaging	Tray
Packaging Quantity	50

General Information	1
Series	TSP
Dielectric	Polymer Tantalum
Style	Stacked Chip
Description	SMD, Polymer, KO, Stacks, High Reliability
Features	High Reliability
RoHS	No
Prop 65	<b>WARNING:</b> Cancer and reproductive harm - http://www.p65warnings.ca.gov.
SCIP Number	30e82d35-b509-48ec-8c77-2d5ec01b3abc
Termination	Solder Coated
Termination (Stack)	Solder Coated
AEC-Q200	No
MSL	3

Specifications	
Capacitance	130 uF
Capacitance Tolerance	20%
Voltage DC	10 VDC (105C), 6.7 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	105°C
<b>Dissipation Factor</b>	8% 120Hz 25C
Failure Rate	C (0.01%/1000 Hrs)
Resistance	20 mOhms (100kHz 25C)
Leakage Current	132 uA (5min 25°C)
Testing and Reliability	10 Cycles Surge Current Testing At +25C +/- 5C After Voltage Aging

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